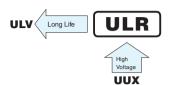


Chip Type, High Voltage.



- Chip Type, high Voltage.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2011/65/EU).

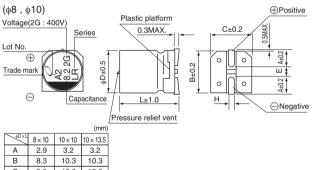




## ■Specifications

Item	Performance Characteristics									
Category Temperature Range	-40 to +105°C									
Rated Voltage Range	160 to 500V									
Rated Capacitance Range	2.7 to 39µF									
Capacitance Tolerance	±20% at 120Hz, 20°C									
Leakage Current	After 1 minute's application of rated voltage, leakage current is not more than 0.04CV +100(μA).									
	Measurement frequency : 120Hz at 20°C									
Tangent of loss angle (tan $\delta$ )	Rated voltage (V) 160 200 250 400 450 500									
	tan δ (MAX.)   0.20   0.25   0.25   0.30   0.30									
	Measurement frequency: 120Hz									
Stability at Law Tamparatura	Rated voltage (V) 160 200 250 400 450 500									
Stability at Low Temperature	Impedance ratio   ZT / Z20 (MAX.)   Z-40°C / Z+20°C   6   6   10   15   15									
	The specifications listed at right shall be met when the Capacitance change Within ±20% of the initial capacitance value									
Endurance	capacitors are restored to 20°C after the rated voltage is tan 8 200% or less than the intial specified value									
	applied for 3000 hours at 105°C.  Leakage current  Less than or equal to the initial specified value									
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.									
Resistance to soldering heat	The capacitors are kept on a hot plate for 30 seconds, which is  Capacitance change   Within ±10% of the initial capacitance value									
	maintained at 250°C and then performing voltage treatment based on tan & Loss than or equal to the initial specified value									
	JIS C 5101-4 clause 4.1 at 20°C, they shall meet the characteristic requirements listed at right when they are removed from the plate.  Leakage current  Less than or equal to the initial specified value									
Marking	Black print on the case top.									

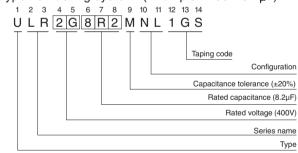
## ■Chip Type



			. ,
φD×L	8×10	10×10	10 × 13.5
Α	2.9	3.2	3.2
В	8.3	10.3	10.3
С	8.3	10.3	10.3
E	3.1	4.5	4.5
L	10 10		13.5
Н	0.8 to 1.1	0.8 to 1.1	0.8 to 1.1

Voltage									
V	160	200	250	400	450	500			
Code	2C	2D	2E	2G	2W	2H			

## Type numbering system (Example : 400V 8.2 $\mu$ F)



## Dimensions

	V	16	60	20	00	25	50	40	0	45	50	50	0
Cap.(µF)	Code	2	C	2D		2E		2G		2W		2H	
2.7	2R7						l I					8×10	20
3.9	3R9									8×10	25	10×10	35
4.7	4R7						i	8×10	35	i		i	
5.6	5R6											10 × 13.5	40
6.8	6R8						!			10×10	40	1	
8.2	8R2						i	10 × 10	50	i		i i	
10	100					8 × 10	35			10 × 13.5	45		
12	120		!	8×10	50		1	10 × 13.5	55	!			
15	150	8×10	50			10×10	50	į i		i		i	
22	220			10×10	65	10 × 13.5	55						
27	270	10 × 10	65				!			!		1	
33	330			10 × 13.5	70		i	i		i		Case size	Rated
39	390	10 × 13.5	70							!		φD×L(mm)	ripple

Rated ripple current (mArms) at 105°C 120Hz

- Frequency coefficient of rated ripple current
- Frequency 50 Hz 120 Hz 300 Hz 1 kHz 10 kHz or more Coefficient 0.80 1.00 1.25 1.40 1.60

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given

in page 18, 19.

Please refer to page 3 for the minimum order quantity.